

AD8108/AD8109 Evaluation Boards

EVAL-AD8108EB/EVAL-AD8109EB

BOARD DESCRIPTION

The four-layer evaluation boards for the AD8108/AD8109 contain the exact same board and use the same external components. The only difference is the device itself, which offers a selection of a gain of unity or gain of two through the analog channels. This board has been carefully laid out and tested to demonstrate the specified high speed performance of the device. Figure 1 shows the schematic of the evaluation board. Figure 2 shows the component side silk-screen. The layouts of the board's four layers are given in Figures 3, 4, 5, and 6.

The evaluation board package includes the following:

- Fully populated board with BNC-type connectors.
- Windows[®] based software for controlling the board from a PC via the printer port.
- Custom cable to connect evaluation board to PC.
- Disk containing Gerber files of board layout.

ORDERING GUIDE

Model	Package Description
AD8108-EB	Evaluation Board
AD8109-EB	Evaluation Board

CAUTION_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the EVAL-AD8108EB/EVAL-AD8109EB features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



REV.0

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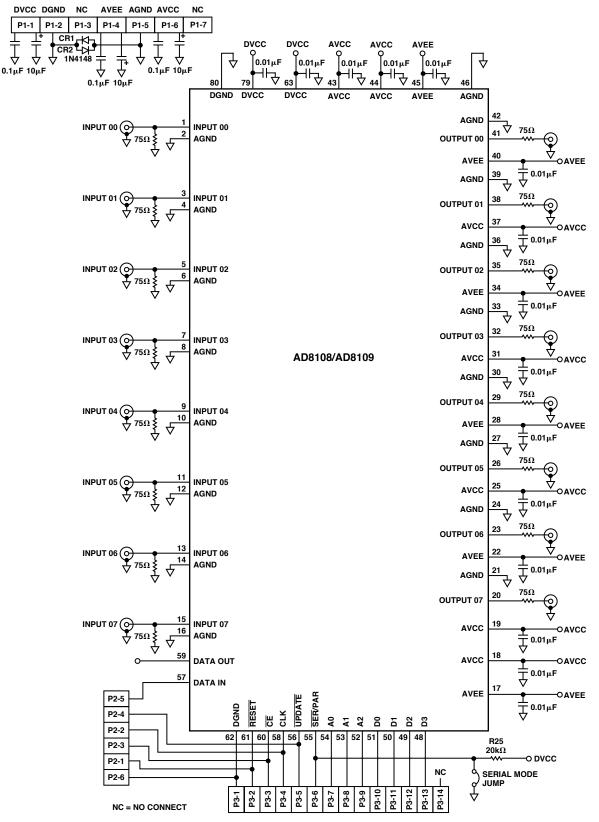


Figure 1. Evaluation Board Schematic

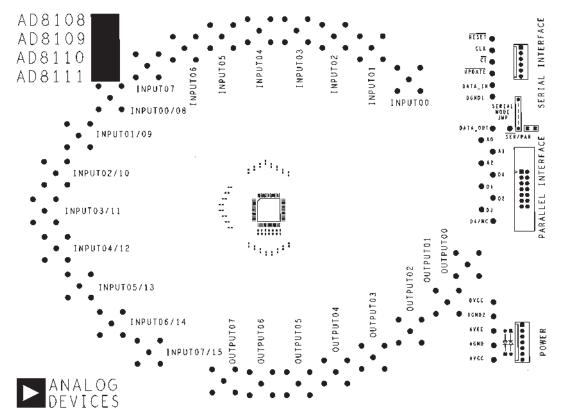


Figure 2. Component Side Silkscreen

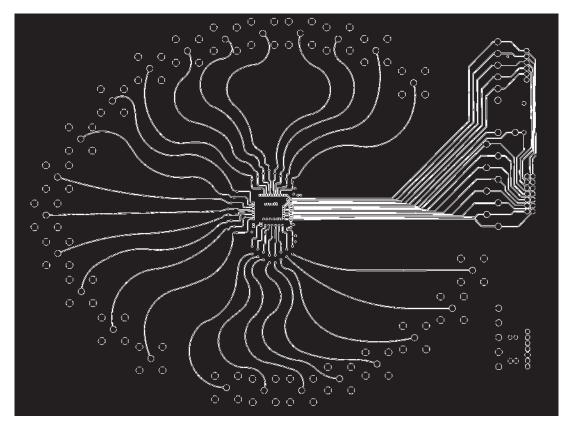


Figure 3. Board Layout (Component Side)

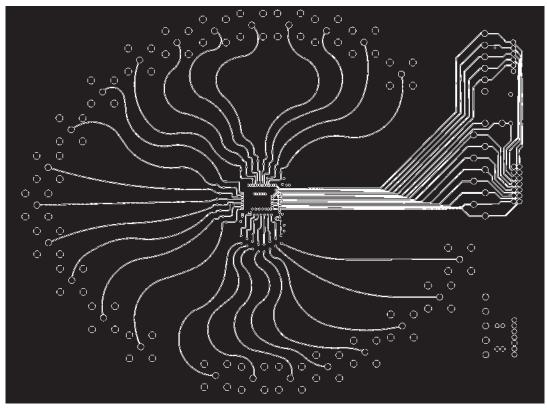


Figure 4. Board Layout (Signal Layer)

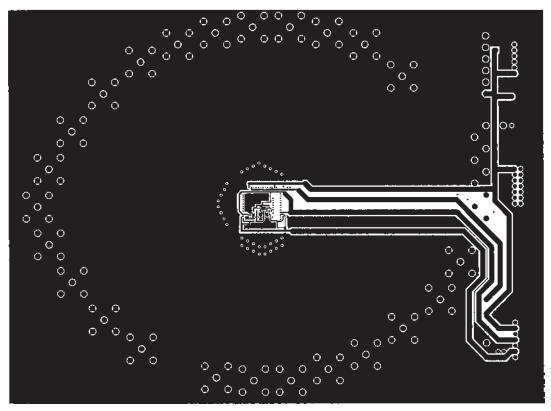


Figure 5. Board Layout (Power Plane)

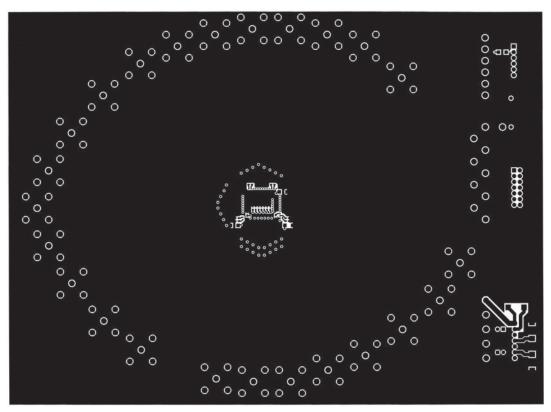
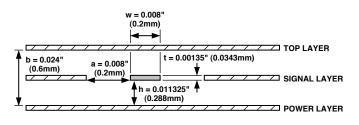


Figure 6. Board Layout (Bottom Layer)

Optimized for video applications, all signal inputs and outputs are terminated with 75 Ω resistors. Stripline techniques are used to achieve a characteristic impedance on the signal input and output lines also of 75 Ω . Figure 7 shows a cross-section of one of the input or output tracks along with the arrangement of the PCB layers. It should be noted that unused regions of the four layers are filled up with ground planes. As a result, the input and output traces, in addition to having controlled impedances, are well shielded.



BOTTOM LAYER

Figure 7. Cross-Section of Input and Output Traces

The board has 16 BNC type connectors: eight inputs and eight outputs. The connectors are arranged in two crescents around the device. As can be seen from Figure 2, this results in all eight input signal traces and all eight signal output traces having the same length. This is useful in tests such as All-Hostile Crosstalk where the phase relationship and delay between signals needs to be maintained from input to output.

The three power supply pins AVCC, DVCC, and AVEE should be connected to good quality, low noise, ± 5 V supplies. Where the same ± 5 V power supplies are used for analog and digital, separate cables should be run from the power supply to the evaluation board's analog and digital power supply pins. As a general rule, each power supply pin (or group of adjacent power supply pins) should be locally decoupled with a 0.01 μ F capacitor. If there is a space constraint, it is more important to decouple analog power supply pins before digital power supply pins. A 0.1 μ F capacitor, located reasonably close to the pins, can be used to decouple a number of power supply pins. Finally, a 10 μ F capacitor should be used to decouple power supplies as they come on to the board.

CONTROLLING THE EVALUATION BOARD FROM A PC

The evaluation board include Windows-based control software and a custom cable that connects the board's digital interface to the printer port of the PC. The wiring of this cable is shown in Figure 8. The software requires Windows 3.1 or later to operate. To install the software, insert the disk labeled "Disk #1 of 2" in the PC and run the file called SETUP.EXE. Additional installation instructions will be given on-screen. Before beginning installation, it is important to terminate any other Windows applications that are running.

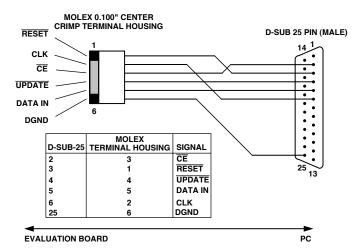


Figure 8. Evaluation Board–PC Connection Cable

When you launch the crosspoint control software, you will be asked to select the printer port you are using. Most modern PCs have only one printer port, usually called LPT1. However, some laptop computers use the PRN port.

Figure 9 shows the main screen of the control software in its initial reset state (all outputs off). Using the mouse, any input can be connected with one or more outputs by simply clicking on the appropriate radio buttons in the 8×8 on-screen array. Each time a button is clicked on, the software automatically sends and latches the required 32-bit data stream to the evaluation board. An output can be turned off by clicking the appropriate button in the Off column. To turn off all outputs, click on Reset.

The software offers volatile and nonvolatile storage of configurations. For volatile storage, up to two configurations can be stored and recalled using the Memory 1 and Memory 2 buffers. These function in an identical fashion to the memory on a pocket calculator. For nonvolatile storage of a configuration, the Save Setup and Load Setup functions can be used. This stores the configuration as a data file on disk.

OVERSHOOT ON PC PRINTER PORTS' DATA LINES

The data lines on some printer ports have excessive overshoot. Overshoot on the pin that is used as the serial clock (Pin 6 on the D-Sub-25 connector) can cause communication problems. This overshoot can be eliminated by connecting a capacitor from the CLK line on the evaluation board to ground. A pad has been provided on the solder-side of the evaluation board to allow this capacitor to be soldered into place. Depending upon the overshoot from the printer port, this capacitor may need to be as large as 0.01 μ F.

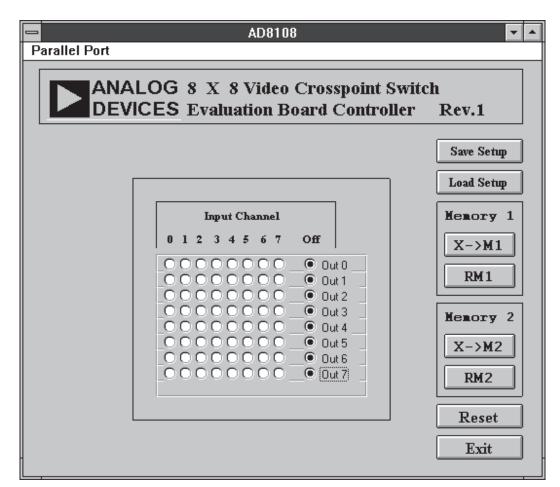


Figure 9. Evaluation Board Control Panel

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